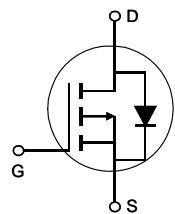
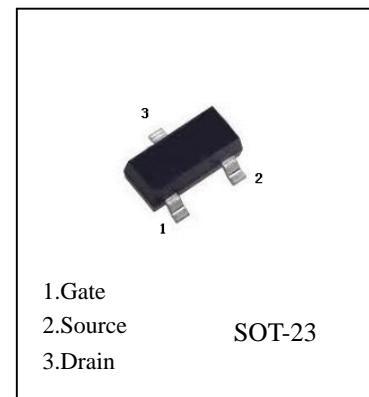


## FEATURES

- The AO3403 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. This device is suitable for use as a load switch or in PWM applications.



**AO3403**  
P-Channel MOSFET



Absolute Maximum Ratings (TA=25°C, unless otherwise noted)

Parameter	Symbol	Maximum		Unit
Drain-Source Voltage	$V_{DS}$	-30		V
Gate-Source Voltage	$V_{GS}$	$\pm 12$		V
Continuous Drain Current T <sub>A</sub> =25°C	$I_D$	-2.6		A
T =70°C		-2.2		
Pulsed Drain Current <sup>C</sup>	$I_{DM}$	-13		
Power Dissipation <sup>B</sup>	$P_D$	1.4		W
T <sub>A</sub> =70°C		0.9		
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150		°C

## Thermal Characteristics

Parameter	Symbol	Typ Max		Unit
Maximum Junction-to-Ambient <sup>A</sup>	$R_{JA}$	70	90	°C/W
Maximum Junction-to-Ambient <sup>A,D</sup>		100	125	°C/W
Maximum Junction-to-Lead	$R_{JL}$	63	80	°C/W

## AO3403

Electrical Characteristics (TA=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> =-250 A, V <sub>GS</sub> =0V	-30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V			-1	uA
			T <sub>j</sub> =55°C		-5	
I <sub>GSS</sub>	Gate-Body leakage current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =-250 A	-0.6	-1	-1.4	V
I <sub>D(ON)</sub>	On state drain current	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-5V	-13			A
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-2.6A		88	115	m
			T <sub>j</sub> =125°C	143	200	
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2A		103	150	m
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1A		139	200	m
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-2.6A		8		S
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =-1A, V <sub>GS</sub> =0V		-0.78	-1	V
I <sub>S</sub>	Maximum Body-Diode Continuous Current				-1.5	A
<b>DYNAMIC PARAMETERS</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =-15V, f=1MHz		260	315	pF
C <sub>oss</sub>	Output Capacitance			37		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			20		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	4	8	12	
<b>SWITCHING PARAMETERS</b>						
Q <sub>g</sub> (10V)	Total Gate Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-2.6A		5.9	7.2	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge			2.8	3.5	nC
Q <sub>gs</sub>	Gate Source Charge			0.7		nC
Q <sub>gd</sub>	Gate Drain Charge			1		nC
t <sub>D(on)</sub>	Turn-On DelayTime	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, R <sub>L</sub> =5.76 , R <sub>GEN</sub> =3		6		ns
t <sub>r</sub>	Turn-On Rise Time			3.5		ns
t <sub>D(off)</sub>	Turn-Off DelayTime			20		ns
t <sub>f</sub>	Turn-Off Fall Time			5		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =-2.6A, dI/dt=100A/ us		11.5	15	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =-2.6A, dI/dt=100A/ us		4.5		nC

A. The value of R<sub>JA</sub> is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C. The value in any given application depends on the user's specific board design.

B. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using ≤ 10s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub>=150°C. Ratings are based on low frequency and duty cycles to keep initial T<sub>j</sub>=25°C.

D. The R<sub>JA</sub> is the sum of the thermal impedance from junction to lead R<sub>jl</sub> and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, assuming a maximum junction temperature of T<sub>J(MAX)</sub>=150°C. The SOA curve provides a single pulse rating.

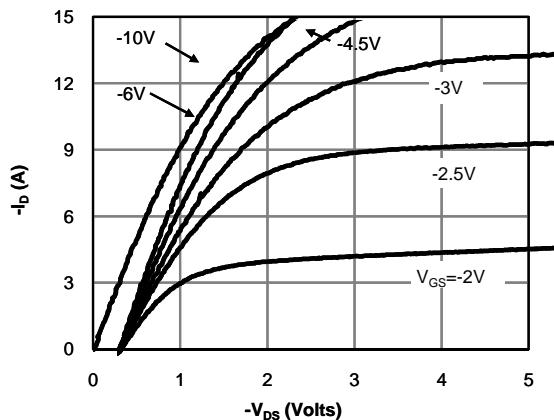
**AO3403 Typical Characteristics**


Fig 1: On-Region Characteristics (Note E)

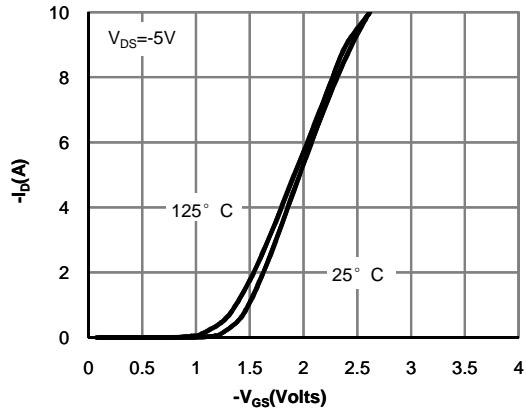


Figure 2: Transfer Characteristics (Note E)

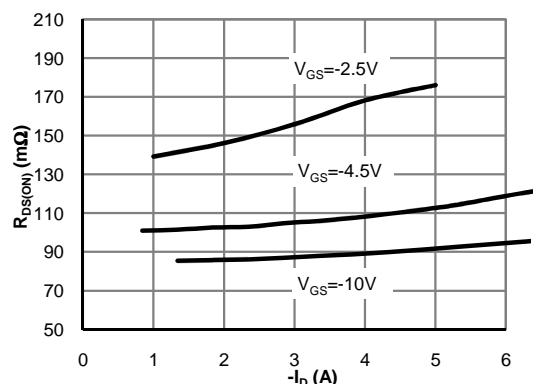


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

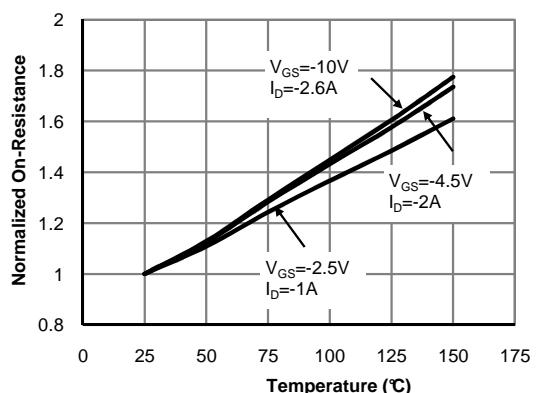


Figure 4: On-Resistance vs. Junction Temperature (Note E)

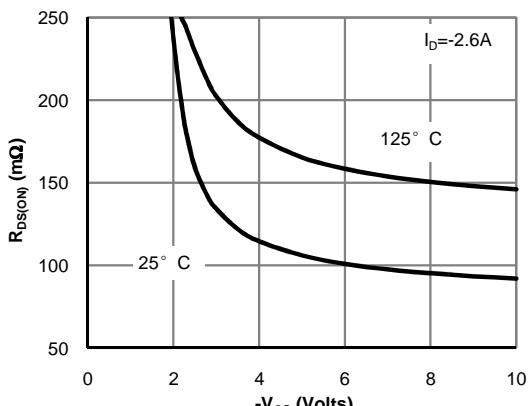


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

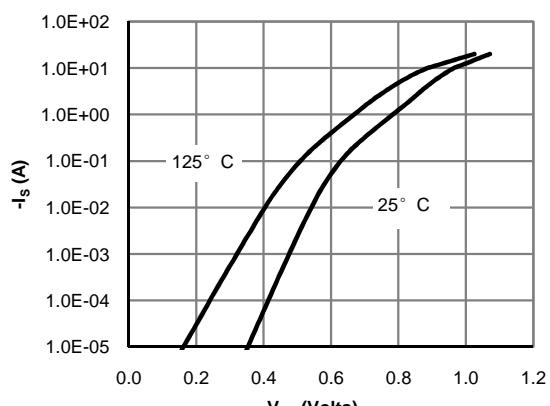


Figure 6: Body-Diode Characteristics (Note E)

## AO3403 Typical Characteristics

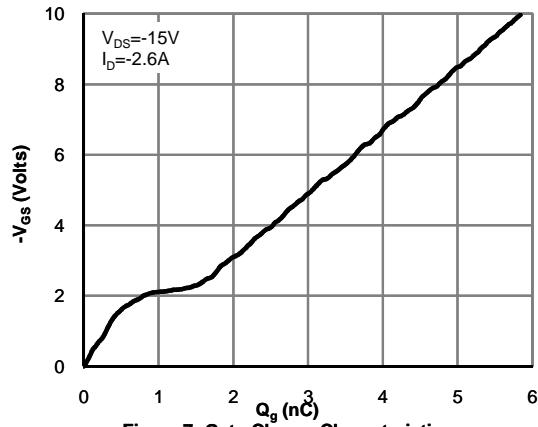


Figure 7: Gate-Charge Characteristics

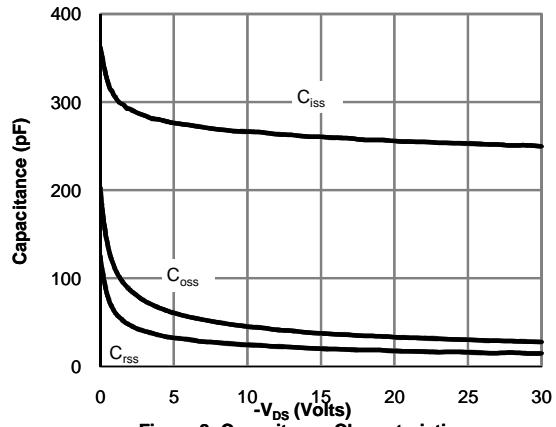


Figure 8: Capacitance Characteristics

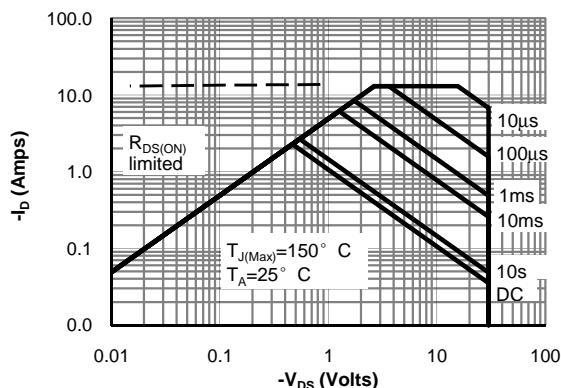


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

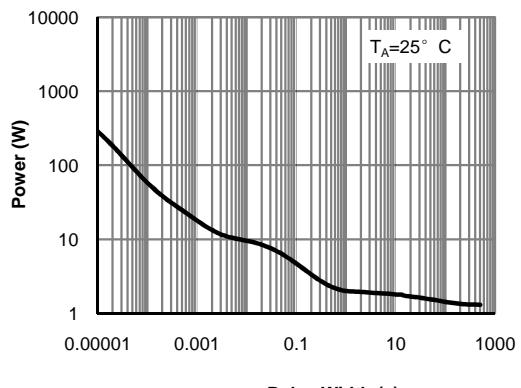


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

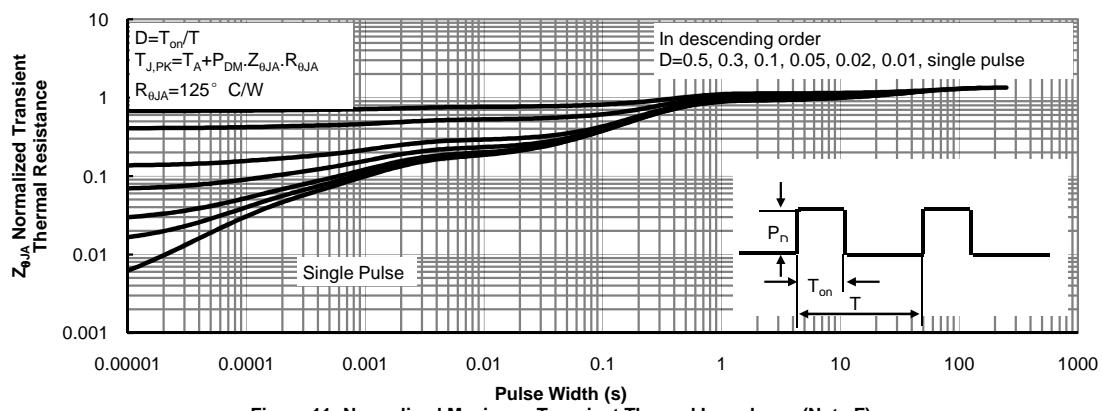


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)